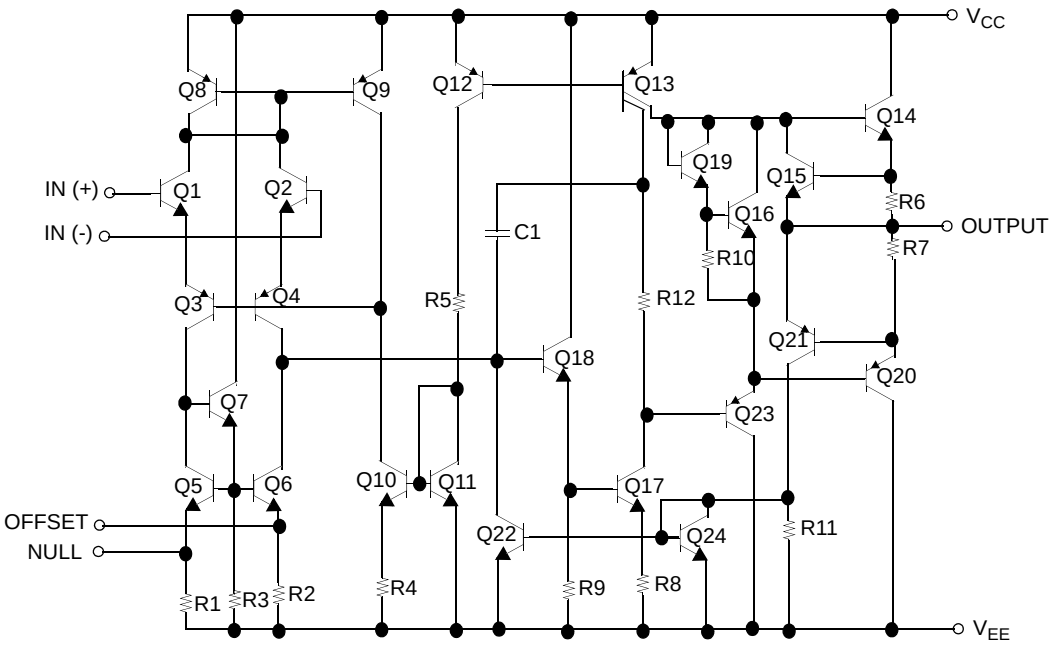
Schematic Diagram



Absolute Maximum Ratings

The “Absolute Maximum Ratings” are those values beyond which the safety of the device cannot be guaranteed. The device should not be operated at these limits. The parametric values defined in the Electrical Characteristics tables are not guaranteed at the absolute maximum ratings. T_A=25°C, unless otherwise specified.

Symbol	Parameter	Value	Unit
V_{CC}	Supply Voltage	±18	V
$V_{I(DIFF)}$	Differential Input Voltage	30	V
V_I	Input Voltage	±15	V
-	Output Short Circuit Duration	Indefinite	-
P_D	Power Dissipation	500	mW
T_{OPR}	Operating Temperature Range	0 ~ +70	°C
T_{STG}	Storage Temperature Range	-65 ~ +150	°C

Electrical Characteristics

(V_{CC} = 15V, V_{EE} = -15V, T_A = 25°C, unless otherwise specified)

Parameter		Symbol	Conditions		Min.	Typ.	Max.	Unit
Input Offset Voltage		V_{IO}	$R_S \le 10k\Omega$		-	2.0	6.0	mV
			$R_S \le 50\Omega$		-	-	-	
Input Offset Voltage Adjustment Range		$V_{IO(R)}$	V_{CC} = ±20V		-	±15	-	mV
Input Offset Current		I_{IO}	-		-	20	200	nA
Input Bias Current		I_{BIAS}	-		-	80	500	nA
Input Resistance (Note1)		R_I	V_{CC} = ±20V		0.3	2.0	-	MΩ
Input Voltage Range		$V_{I(R)}$	-		±12	±13	-	V
Large Signal Voltage Gain		G_V	$R_L \ge 2k\Omega$	V_{CC} = ±20V, $V_{O(P-P)}$ = ±15V	-	-	-	V/mV
				V_{CC} = ±15V, $V_{O(P-P)}$ = ±10V	20	200	-	
Output Short Circuit Current		I_{SC}	-		-	25	-	mA
Output Voltage Swing		$V_{O(P-P)}$	V_{CC} = ±20V	$R_L \ge 10k\Omega$	-	-	-	V
				$R_L \ge 2k\Omega$	-	-	-	
			V_{CC} = ±15V	$R_L \ge 10k\Omega$	±12	±14	-	
				$R_L \ge 2k\Omega$	±10	±13	-	
Common Mode Rejection Ratio		CMRR	$R_S \le 10k\Omega$, V_{CM} = ±12V		70	90	-	dB
			$R_S \le 50\Omega$, V_{CM} = ±12V		-	-	-	
Power Supply Rejection Ratio		PSRR	V_{CC} = ±15V to V_{CC} = ±15V $R_S \le 50\Omega$		-	-	-	dB
			V_{CC} = ±15V to V_{CC} = ±15V $R_S \le 10k\Omega$		77	96	-	
Transient	Rise Time	T_R	Unity Gain		-	0.3	-	µs
Response	Overshoot	OS			-	10	-	%
Bandwidth		BW	-		-	-	-	MHz
Slew Rate		SR	Unity Gain		-	0.5	-	V/µs
Supply Current		I_{CC}	R_L= ∞Ω		-	1.5	2.8	mA
Power Consumption		P_C	V_{CC} = ±20V		-	-	-	mW
			V_{CC} = ±15V		-	50	85	

Note:

1. Guaranteed by design.

Electrical Characteristics (Continued)

(0°C ≤ T_A ≤ 70 °C, V_{CC} = ±15V, unless otherwise specified)
The following specification apply over the range of 0°C ≤ T_A ≤ +70°C for the LM741C

Parameter	Symbol	Conditions		Min.	Typ.	Max.	Unit
Input Offset Voltage	V_{IO}	R_S ≤ 50Ω		-	-	-	mV
		R_S ≤ 10kΩ		-	-	7.5	
Input Offset Voltage Drift	$\Delta V_{IO}/\Delta T$	-		-	-		µV/°C
Input Offset Current	I_{IO}	-		-	-	300	nA
Input Offset Current Drift	$\Delta I_{IO}/\Delta T$	-		-	-		nA/°C
Input Bias Current	I_{BIAS}	-		-	-	0.8	µA
Input Resistance (Note1)	R_I	V_{CC} = ±20V		-	-	-	MΩ
Input Voltage Range	$V_{I(R)}$	-		±12	±13	-	V
Output Voltage Swing	$V_{O(P-P)}$	V_{CC} =±20V	R_S ≥ 10kΩ	-	-	-	V
			R_S ≥ 2kΩ	-	-	-	
		V_{CC} =±15V	R_S ≥ 10kΩ	±12	±14	-	
			R_S ≥ 2kΩ	±10	±13	-	
Output Short Circuit Current	I_{SC}	-		10	-	40	mA
Common Mode Rejection Ratio	CMRR	R_S ≤ 10kΩ, V_{CM} = ±12V		70	90	-	dB
		R_S ≤ 50Ω, V_{CM} = ±12V		-	-	-	
Power Supply Rejection Ratio	PSRR	V_{CC} = ±20V to ±5V	R_S ≤ 50Ω	-	-	-	dB
			R_S ≤ 10kΩ	77	96	-	
Large Signal Voltage Gain	G_V	R_S ≥ 2kΩ	V_{CC} = ±20V, $V_{O(P-P)}$ = ±15V	-	-	-	V/mV
			V_{CC} = ±15V, $V_{O(P.P)}$ = ±10V	15	-	-	
			V_{CC} = ±15V, $V_{O(P-P)}$ = ±2V	-	-	-	

Note :
1. Guaranteed by design.

Typical Performance Characteristics

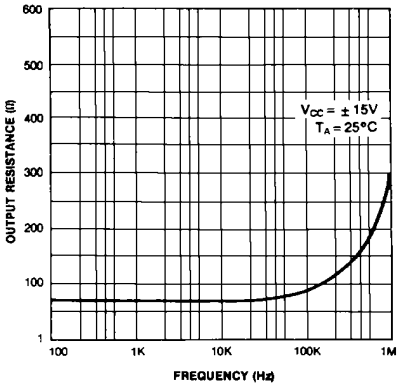


Figure 1. Output Resistance vs Frequency

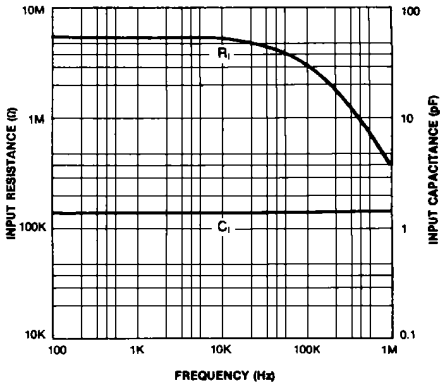


Figure 2. Input Resistance and Input Capacitance vs Frequency

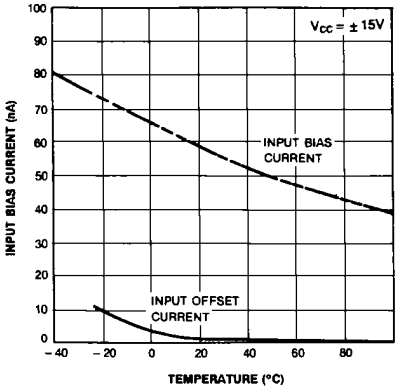


Figure 3. Input Bias Current vs Ambient Temperature

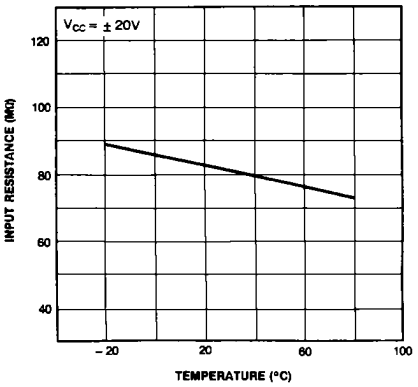


Figure 4. Power Consumption vs Ambient Temperature

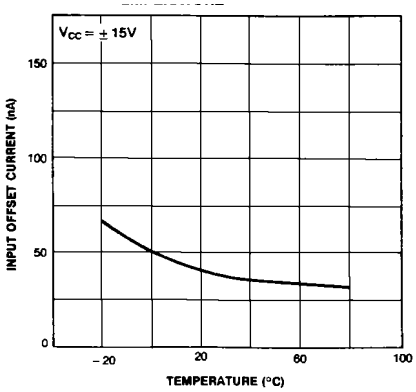


Figure 5. Input Offset Current vs Ambient Temperature

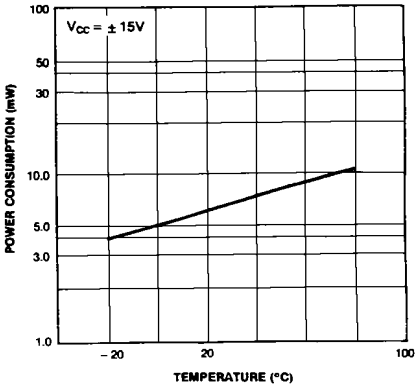


Figure 6. Input Resistance vs Ambient Temperature

Typical Performance Characteristics (Continued)

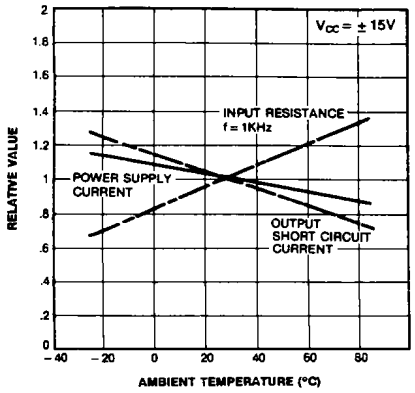


Figure 7. Normalized DC Parameters vs Ambient Temperature

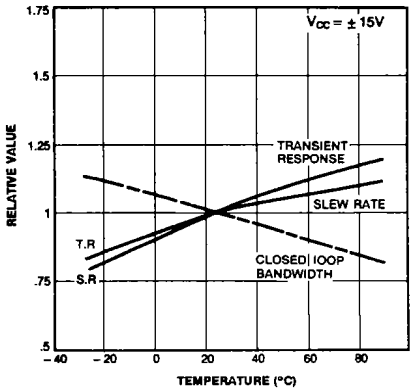


Figure 8. Frequency Characteristics vs Ambient Temperature

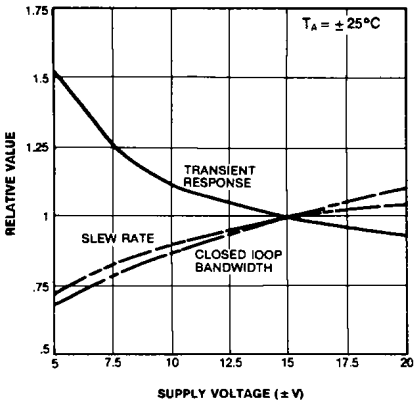


Figure 9. Frequency Characteristics vs Supply Voltage

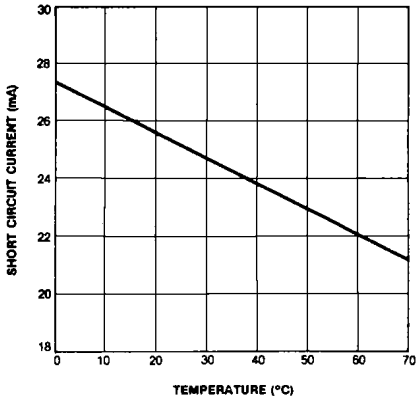


Figure 10. Output Short Circuit Current vs Ambient Temperature

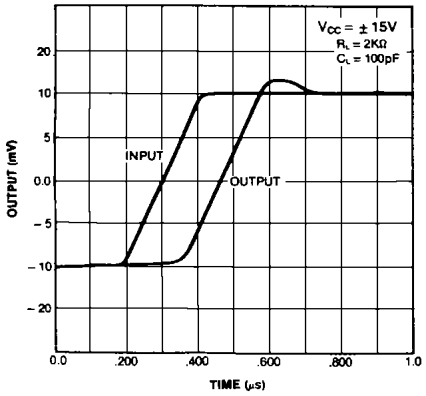


Figure 11. Transient Response

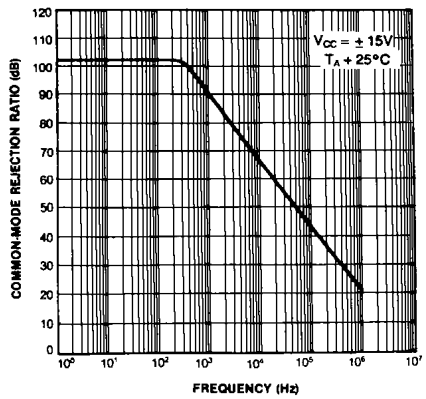


Figure 12. Common-Mode Rejection Ratio vs Frequency

Typical Performance Characteristics (Continued)

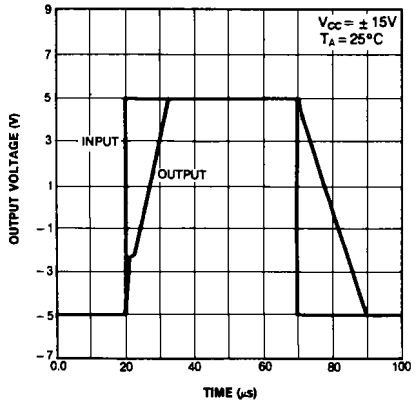


Figure 1. Voltage Follower Large Signal Pulse Response

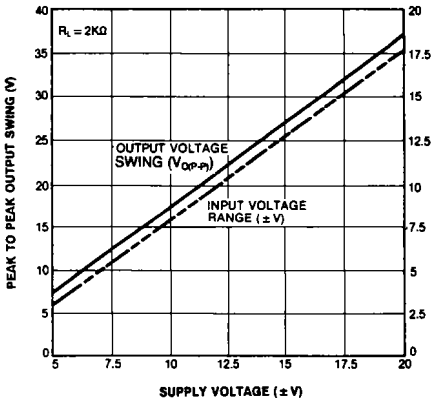
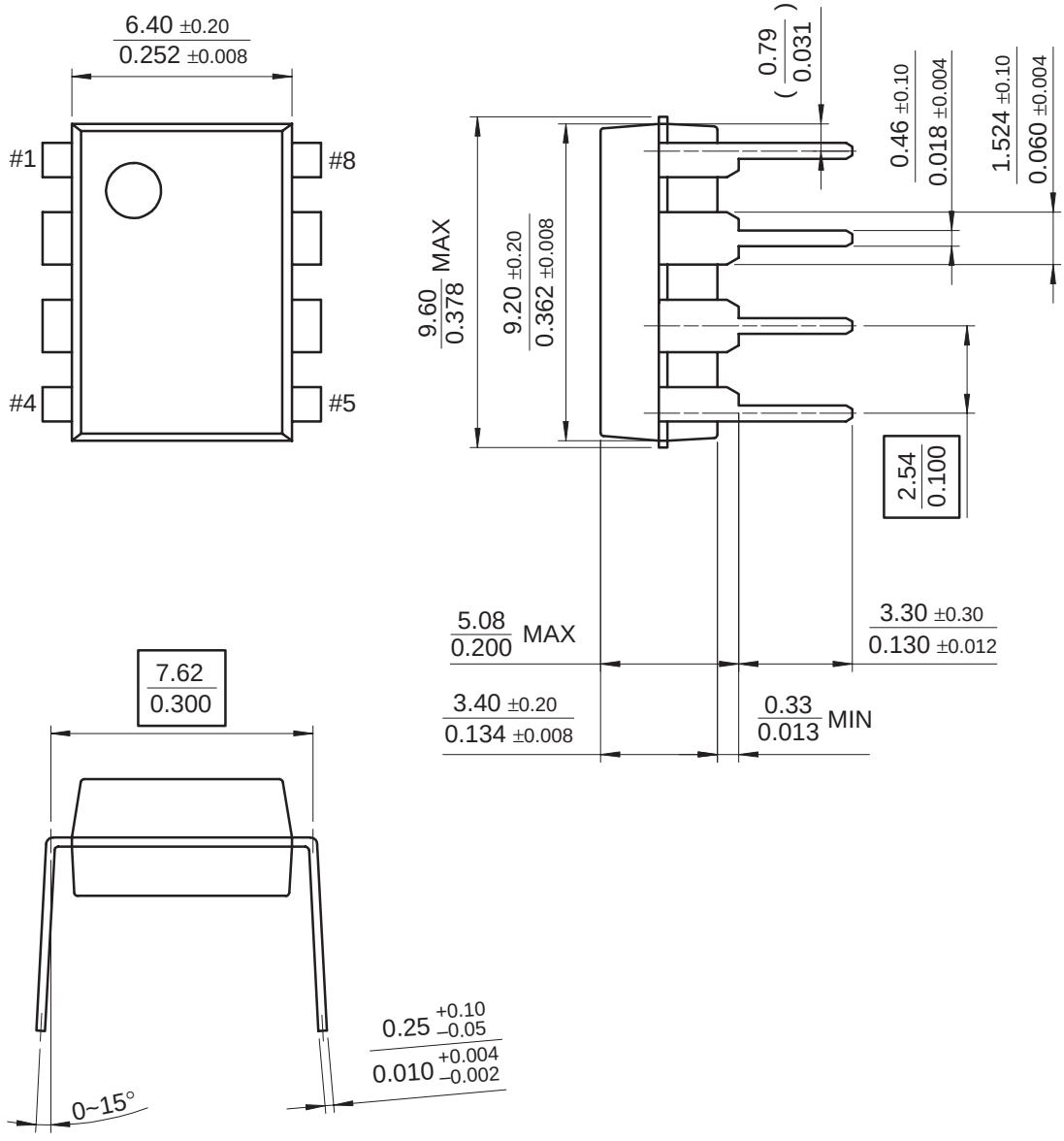


Figure 2. Output Swing and Input Range vs Supply Voltage

Package

Dimensions in millimeters

8-DIP

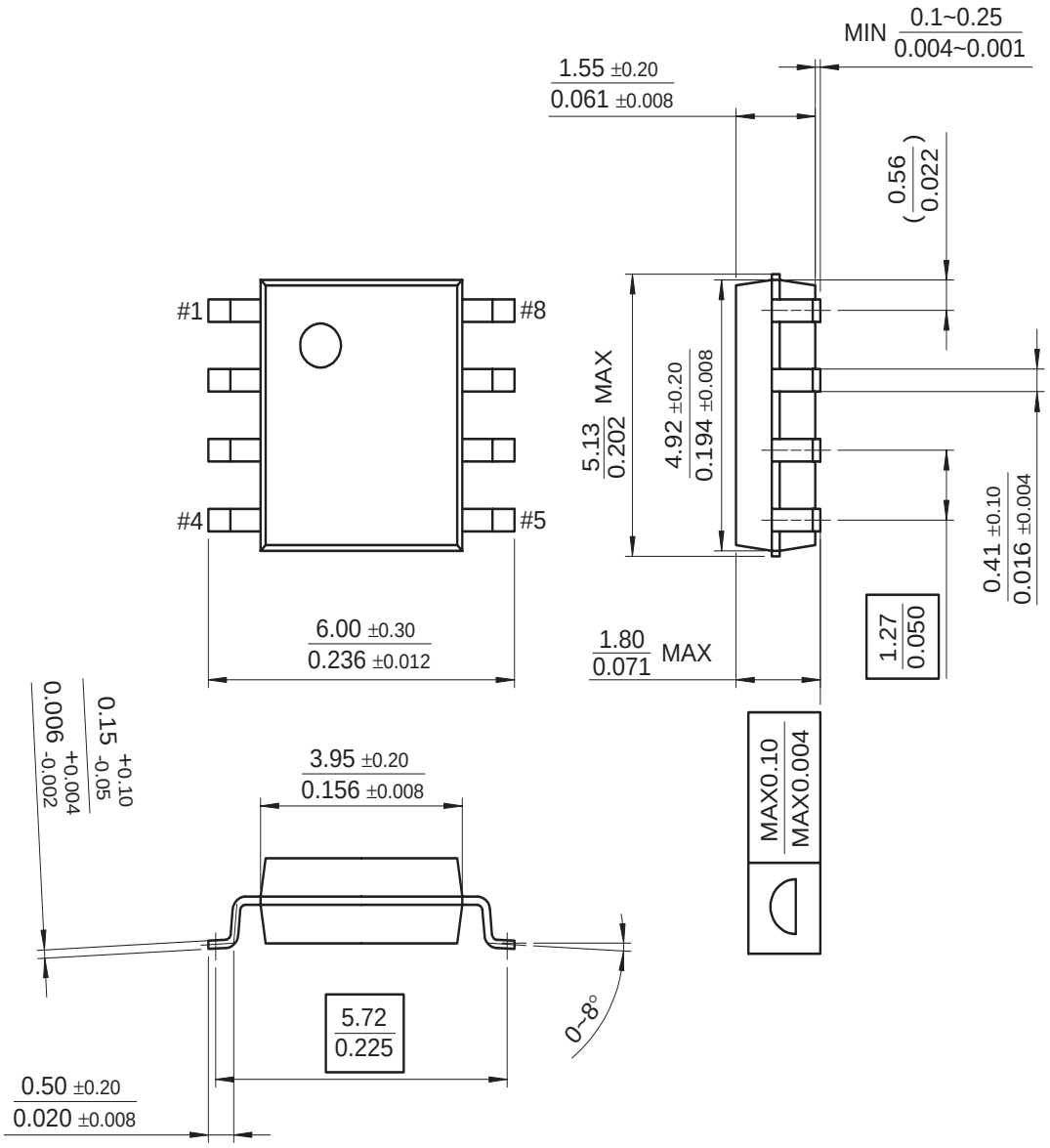


Mechanical Dimensions (Continued)

Package

Dimensions in millimeters

8-SOP



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